

Application No. 10/619,334  
Attorney Docket No. 10112451

September 21, 2004

#### **AMENDMENTS TO THE SPECIFICATION**

Please replace the paragraph at page 9, line 17 with the following rewritten paragraph:

– Fig. 6[[A]] is a photograph illustrating experimental results from example 3 of the working examples described.

Please replace the paragraph at page 23, line 16 with the following rewritten paragraph:

– Fig. 6[[A]] is a photograph illustrating experimental results from example 3 of the working examples described. The difference between examples 3 and 1 is that the encapsulant overlying the third substrate of example 3 is not pressurized as in the first embodiment. The voids recorded before step 7 are not substantially improved after step 7, remaining in the hardened molding compound overlying the third substrate.